| L Number | Hits | Search Text | DB | Time stamp |
|----------|--------|---|---------------------|--------------------|
| 1 | 184843 | semiconductor and wafer | USPAT; | 2003/01/11 16:23 |
| | | | US-PGPUB; | |
| | | , | EPO; JPO; | |
| | | | DERWENT | |
| 2 | 5036 | (semiconductor and wafer) and (process | USPAT; | 2003/01/11 16:24 |
| | | near1 control) | US-PGPUB; | |
| | | | EPO; JPO; | |
| | | | DERWENT | |
| 3 | 5036 | , · · · · · · · · · · · · · · · · · · · | USPAT; | 2003/01/11 16:29 |
| | | near control) | US-PGPUB; | |
| | | | EPO; JPO; | |
| | | | DERWENT | 0000 (01 (11 16 00 |
| 4 | 3 | "5990488" | USPAT; | 2003/01/11 16:28 |
| | | | US-PGPUB; | |
| | | | EPO; JPO; | 1 |
| _ | | /# / A CT / O O W W A A T O O O O W W A T 1 T C F O W | DERWENT | 2002/01/11 16:26 |
| 5 | 9 | ("4467400" "4479088" "4517659" | USPAT | 2003/01/11 16:26 |
| | | "4920454" "5309011" "5391892" | | |
| | 122 | "5514884" "5648661" "5654588").PN. | USPAT; | 2003/01/11 16:30 |
| 6 | 132 | (semiconductor and wafer) and ((process | USPAT; US-PGPUB; | 2003/01/11 16:30 |
| | | near control) near1 (module monitor)) | EPO; JPO; | |
| | | | DERWENT | |
| 7 | 29 | ((semiconductor and wafer) and ((process | USPAT; | 2003/01/11 16:30 |
| / | 29 | near control) near1 (module monitor))) and | US-PGPUB; | 2003/01/11 10:30 |
| | | (chip die) | EPO; JPO; | |
| | | (Chip die) | DERWENT | |
| 8 | _ | 5990488.URPN. | USPAT | 2003/01/11 16:42 |
| 9 | Ö | i e e e e e e e e e e e e e e e e e e e | USPAT | 2003/01/11 16:42 |
| 10 | 9 | ("4467400" "4479088" "4517659" | USPAT | 2003/01/11 16:42 |
| = • | | "4920454" "5309011" "5391892" | | |
| | | "5514884" "5648661" "5654588").PN. | | |
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